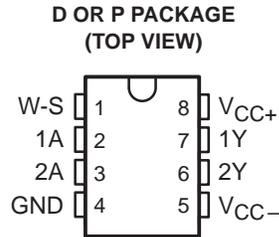


# uA9636AC

## DUAL LINE DRIVER WITH ADJUSTABLE SLEW RATE

SLLS110B – OCTOBER 1980 – REVISED MAY 1995

- Meets or Exceeds the Requirements of ANSI Standards EIA/TIA-423-B and -232-E and ITU Recommendations V.10 and V.28
- Output Slew Rate Control
- Output Short-Circuit-Current Limiting
- Wide Supply Voltage Range
- 8-Pin Package
- Designed to Be Interchangeable With National DS9636A

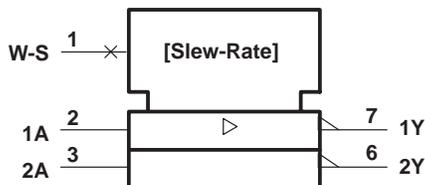


### description

The uA9636AC is a dual, single-ended line driver designed to meet ANSI Standards EIA/TIA-423-B and EIA/TIA-232-E and ITU Recommendations V.10 and V.28. The slew rates of both amplifiers are controlled by a single external resistor,  $R_{(WS)}$ , connected between the wave-shape-control (W-S) terminal and GND. Output current limiting is provided. Inputs are compatible with TTL and CMOS and are diode protected against negative transients. This device operates from  $\pm 12$  V and is supplied in an 8-pin package.

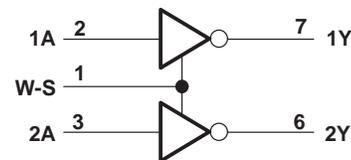
The uA9636AC is characterized for operation from 0°C to 70°C.

### logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

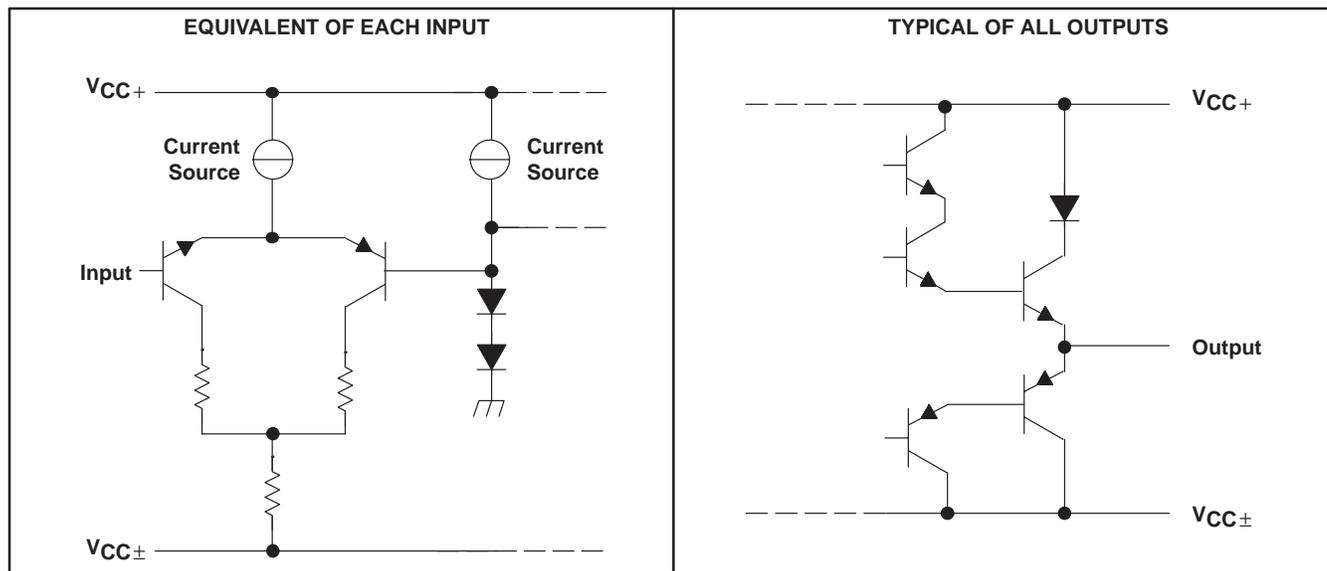
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# uA9636AC DUAL LINE DRIVER WITH ADJUSTABLE SLEW RATE

SLLS110B – OCTOBER 1980 – REVISED MAY 1995

## schematics of inputs and outputs



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Positive supply voltage range, $V_{CC+}$ (see Note 1)	$V_{CC-}$ to 15 V
Negative supply voltage range, $V_{CC-}$	0.5 V to -15 V
Output voltage, $V_O$	$\pm 15$ V
Output current, $I_O$	$\pm 150$ mA
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, $T_A$	0°C to 70°C
Storage temperature range, $T_{stg}$	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to the network ground terminal.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING
D	725 mW	5.8 mW/°C	464 mW
P	1000 mW	8.0 mW/°C	640 mW

### recommended operating conditions

	MIN	NOM	MAX	UNIT
Positive supply voltage, $V_{CC+}$	10.8	12	13.2	V
Negative supply voltage, $V_{CC-}$	-10.8	-12	-13.2	V
High-level input voltage, $V_{IH}$	2			V
Low-level input voltage, $V_{IL}$			0.8	V
Wave-shaping resistor, $R_{(WS)}$	10		1000	k $\Omega$
Operating free-air temperature, $T_A$	0		70	°C



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# uA9636AC

## DUAL LINE DRIVER WITH ADJUSTABLE SLEW RATE

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**electrical characteristics over recommended ranges of free-air temperature, supply voltage, and wave-shaping resistance (unless otherwise noted)**

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>†</sup>	MAX	UNIT
V <sub>IK</sub>	Input clamp voltage	I <sub>I</sub> = -15 mA		-1.1	-1.5		V
V <sub>OH</sub>	High-level output voltage	V <sub>I</sub> = 0.8 V	R <sub>L</sub> = ∞	5	5.6	6	V
			R <sub>L</sub> = 3 kΩ to GND	5	5.6	6	
			R <sub>L</sub> = 450 Ω to GND	4	5.4	6	
V <sub>OL</sub>	Low-level output voltage	V <sub>I</sub> = 2 V	R <sub>L</sub> = ∞	-6 <sup>‡</sup>	-5.7	-5	V
			R <sub>L</sub> = 3 kΩ to GND	-6 <sup>‡</sup>	-5.6	-5	
			R <sub>L</sub> = 450 Ω to GND	-6 <sup>‡</sup>	-5.4	-4	
I <sub>IH</sub>	High-level input current	V <sub>I</sub> = 2.4 V				10	μA
		V <sub>I</sub> = 5.5 V				100	
I <sub>IL</sub>	Low-level input current	V <sub>I</sub> = 0.4 V			-20	-80	μA
I <sub>O</sub>	Output current (power off)	V <sub>CC±</sub> = 0, V <sub>O</sub> = ±6 V				±100	μA
I <sub>OS</sub>	Short-circuit output current <sup>§</sup>	V <sub>I</sub> = 2 V		15	25	150	mA
		V <sub>I</sub> = 0		-15	-40	-150	
r <sub>O</sub>	Output resistance	R <sub>L</sub> = 450 Ω			25	50	Ω
I <sub>CC+</sub>	Positive supply current	V <sub>CC</sub> = ±12 V, R <sub>(WS)</sub> = 100 kΩ,	V <sub>I</sub> = 0, Output open		13	18	mA
I <sub>CC-</sub>	Negative supply current	V <sub>CC</sub> = ±12 V, R <sub>(WS)</sub> = 100 kΩ,	V <sub>I</sub> = 0, Output open		-13	-18	mA

<sup>†</sup> All typical values are at V<sub>CC</sub> = ±12 V, T<sub>A</sub> = 25°C.

<sup>‡</sup> The algebraic convention, in which the less-positive (more-negative) limit is designated as minimum, is used in this data sheet for logic voltage levels, e.g., when -5 V is the maximum, the minimum is a more-negative voltage.

<sup>§</sup> Not more than one output should be shorted to ground at a time.

### switching characteristics, V<sub>CC±</sub> = ±12 V, T<sub>A</sub> = 25°C (see Figure 1)

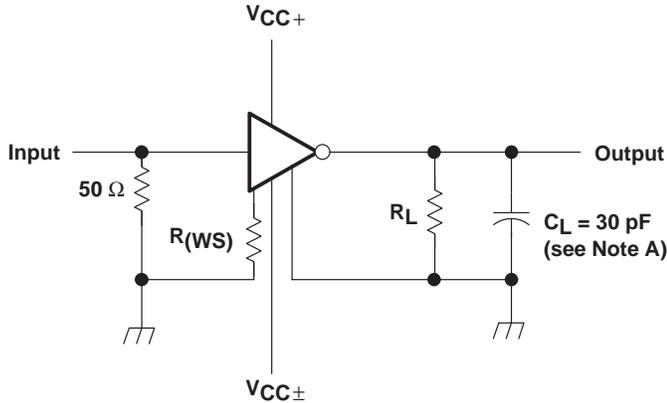
PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
t <sub>TLH</sub>	Transition time, low- to high-level output	R <sub>L</sub> = 450 kΩ, C <sub>L</sub> = 30 pF	R <sub>(WS)</sub> = 10 kΩ	0.8	1.1	1.4	μs
			R <sub>(WS)</sub> = 100 kΩ	8	11	14	
			R <sub>(WS)</sub> = 500 kΩ	40	55	70	
			R <sub>(WS)</sub> = 1 MΩ	80	110	140	
t <sub>THL</sub>	Transition time, high- to low-level output	R <sub>L</sub> = 450 kΩ, C <sub>L</sub> = 30 pF	R <sub>(WS)</sub> = 10 kΩ	0.8	1.1	1.4	μs
			R <sub>(WS)</sub> = 100 kΩ	8	11	14	
			R <sub>(WS)</sub> = 500 kΩ	40	55	70	
			R <sub>(WS)</sub> = 1 MΩ	80	110	140	



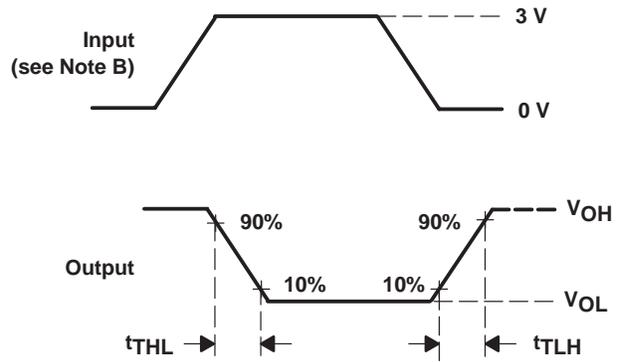
# uA9636AC DUAL LINE DRIVER WITH ADJUSTABLE SLEW RATE

SLLS110B – OCTOBER 1980 – REVISED MAY 1995

## PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



VOLTAGE WAVEFORMS

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The input pulse is supplied by a generator having the following characteristics:  $t_r \leq 10$  ns,  $t_f \leq 10$  ns,  $Z_0 = 50 \Omega$ ,  $PRR \leq 1$  kHz, duty cycle = 50%.

Figure 1. Test Circuit and Voltage Waveforms

## TYPICAL CHARACTERISTICS

OUTPUT VOLTAGE  
vs  
INPUT VOLTAGE

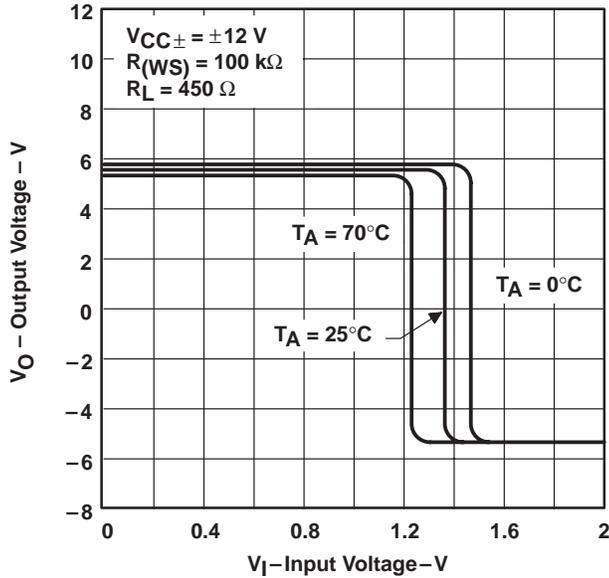


Figure 2

INPUT CURRENT  
vs  
INPUT VOLTAGE

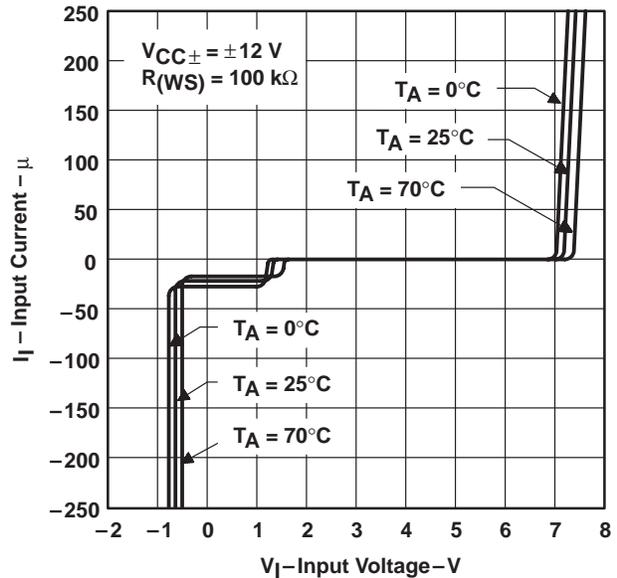
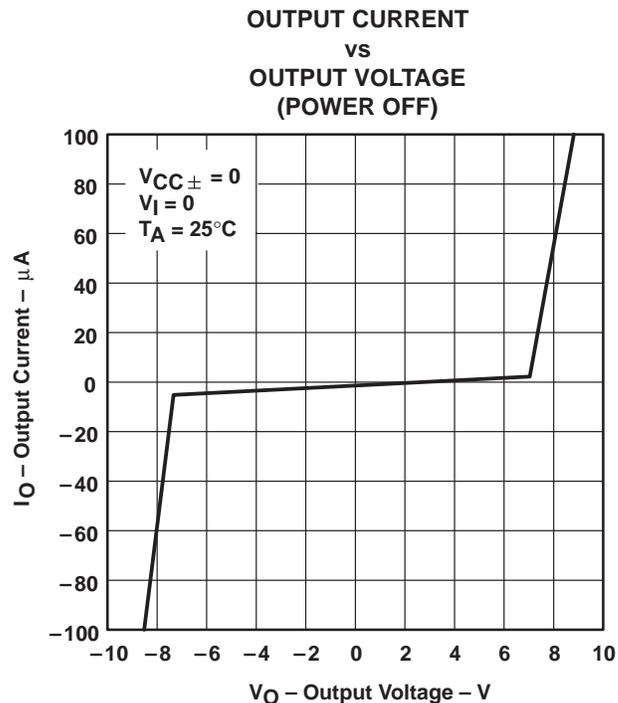
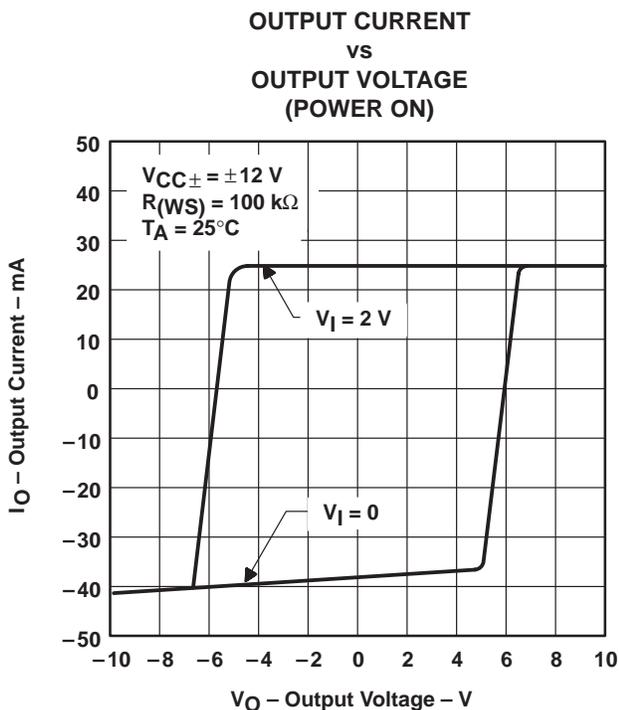
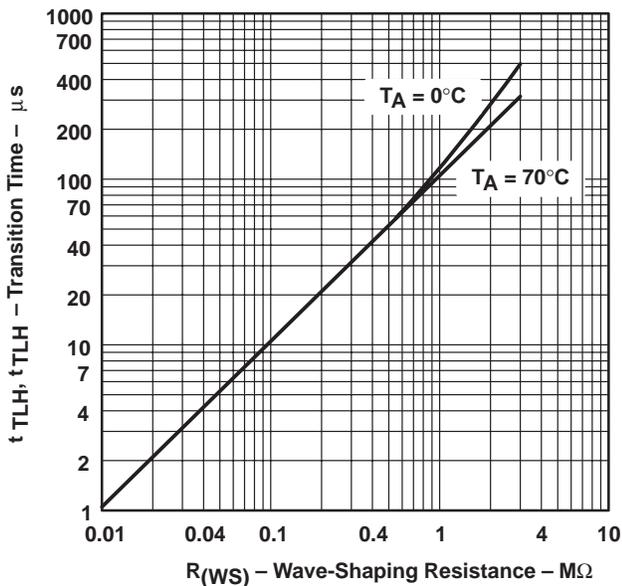


Figure 3

**TYPICAL CHARACTERISTICS**



**TRANSITION TIME  
vs  
WAVE-SHAPING RESISTANCE**



# uA9636AC DUAL LINE DRIVER WITH ADJUSTABLE SLEW RATE

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## APPLICATION INFORMATION

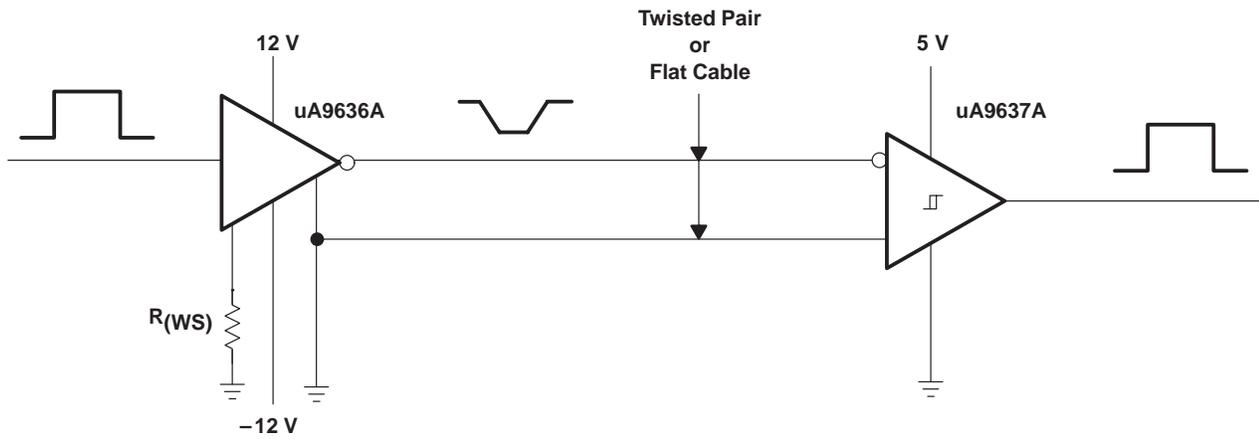


Figure 7. EIA/TIA-423-B System Application

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
UA9636ACD	LIFEBUY	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	9636AC	
UA9636ACDR	LIFEBUY	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	9636AC	
UA9636ACP	LIFEBUY	PDIP	P	8	50	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	UA9636ACP	
UA9636ACPE4	LIFEBUY	PDIP	P	8	50	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	UA9636ACP	

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

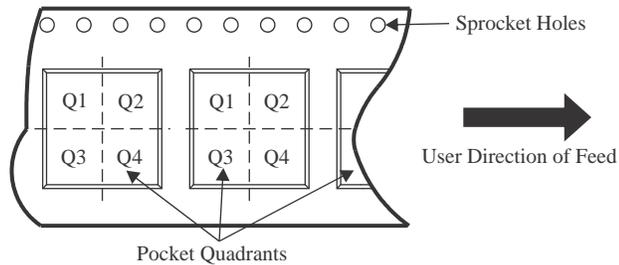
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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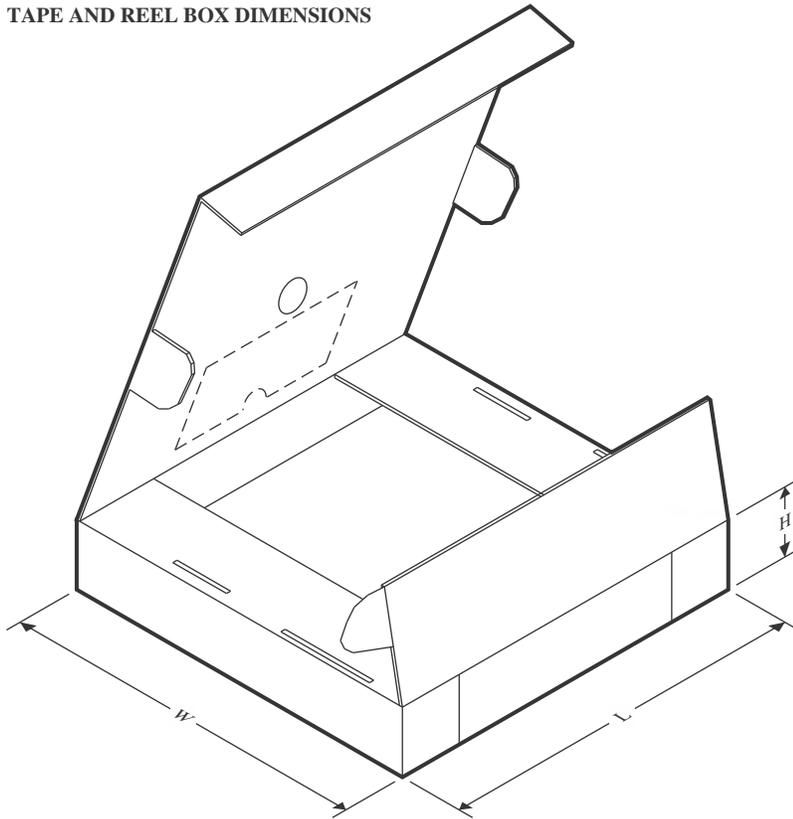
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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


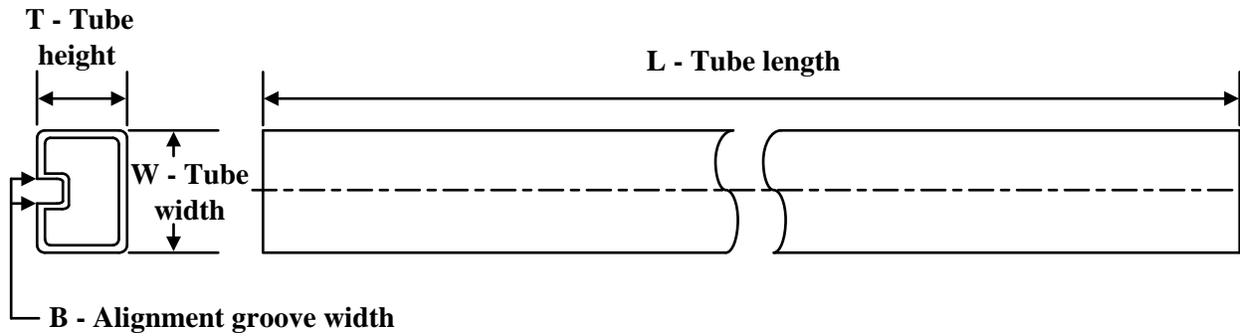
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UA9636ACDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


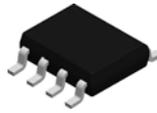
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UA9636ACDR	SOIC	D	8	2500	340.5	336.1	25.0

**TUBE**


\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
UA9636ACD	D	SOIC	8	75	507	8	3940	4.32
UA9636ACP	P	PDIP	8	50	506	13.97	11230	4.32
UA9636ACPE4	P	PDIP	8	50	506	13.97	11230	4.32

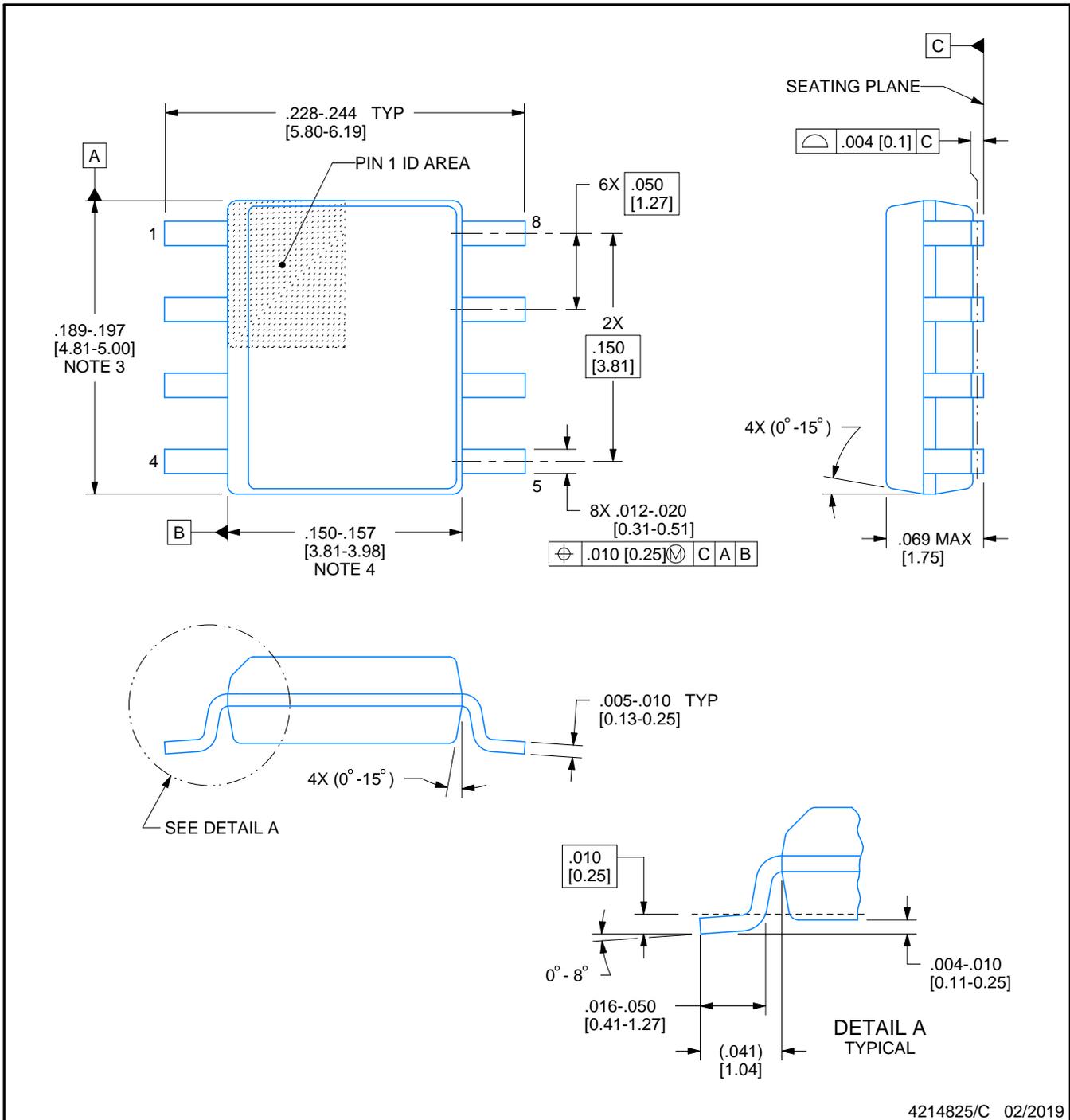


D0008A

# PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

### NOTES:

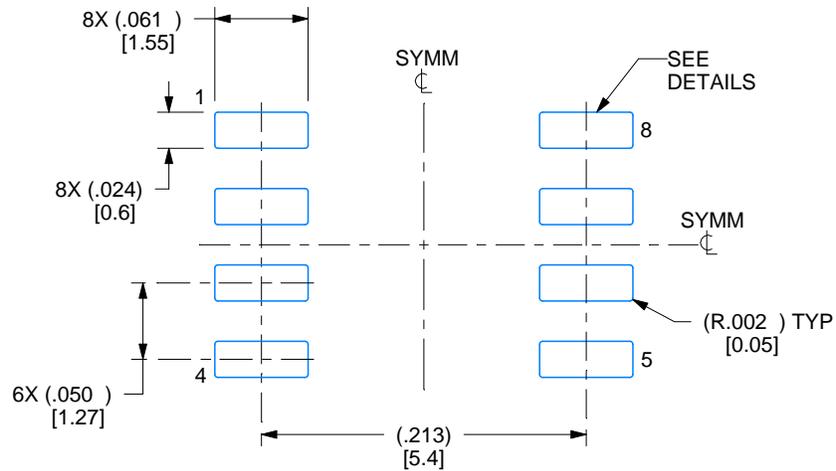
- Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed  $.006$  [0.15] per side.
- This dimension does not include interlead flash.
- Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

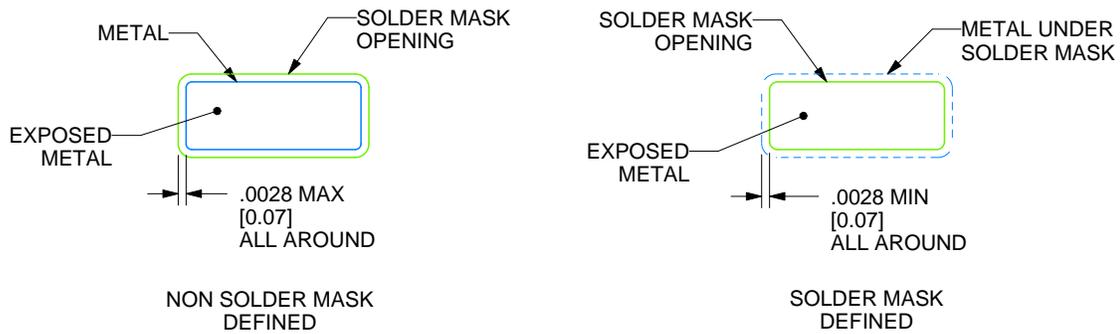
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



SOLDER MASK DETAILS

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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

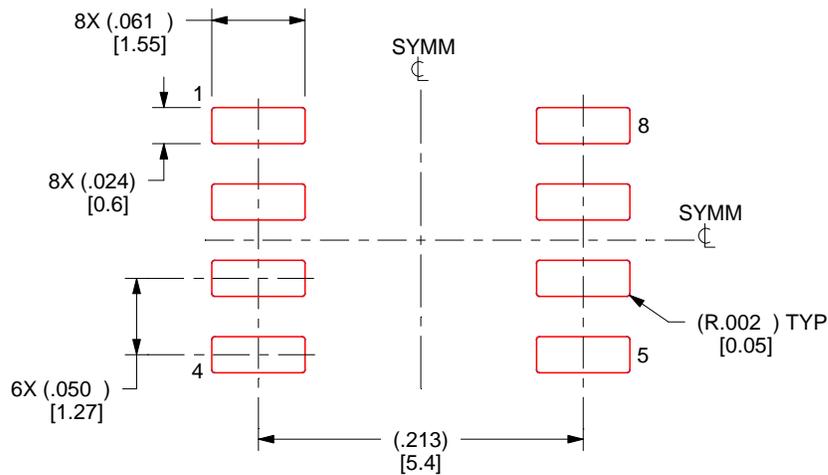
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

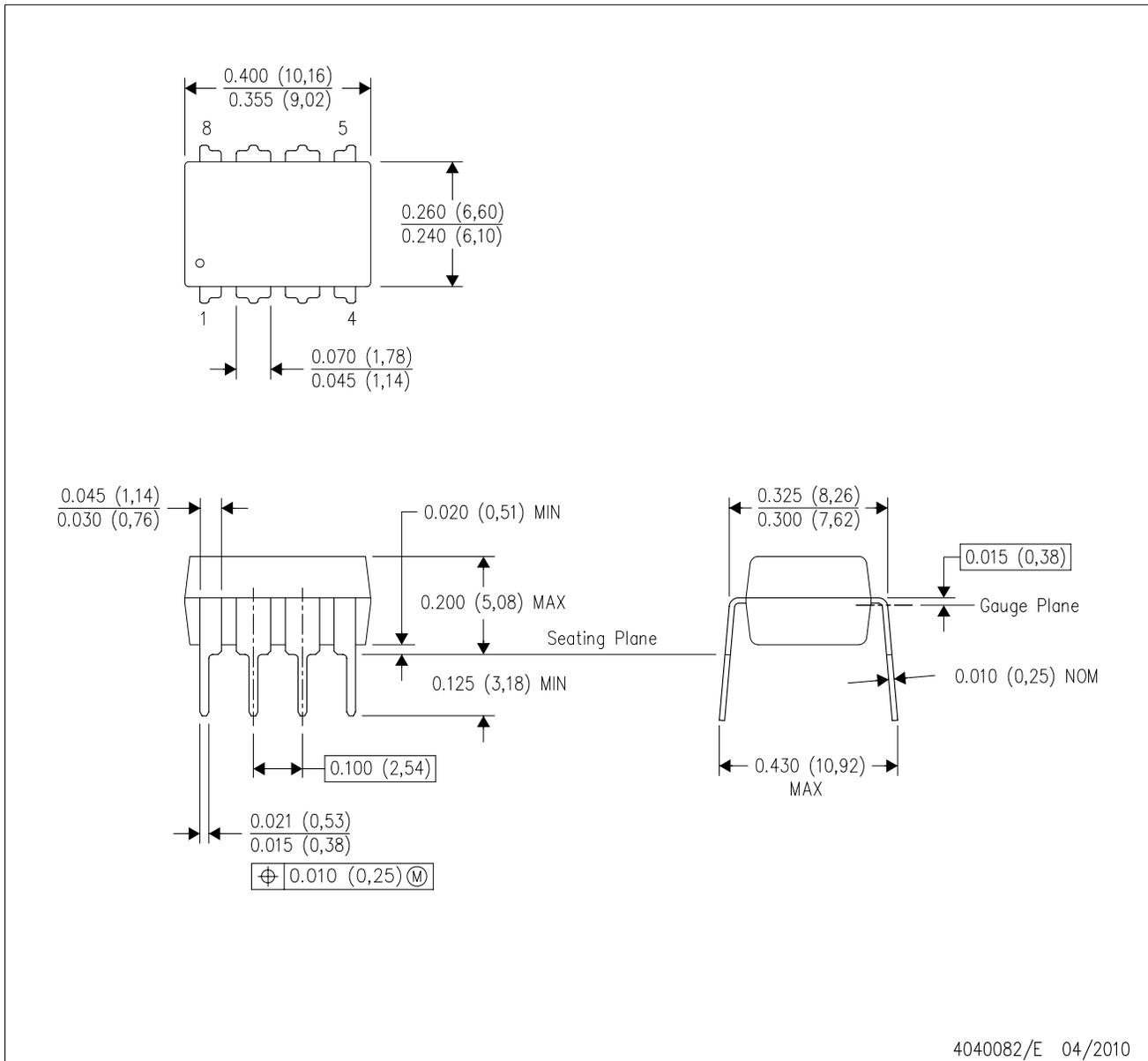
4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

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